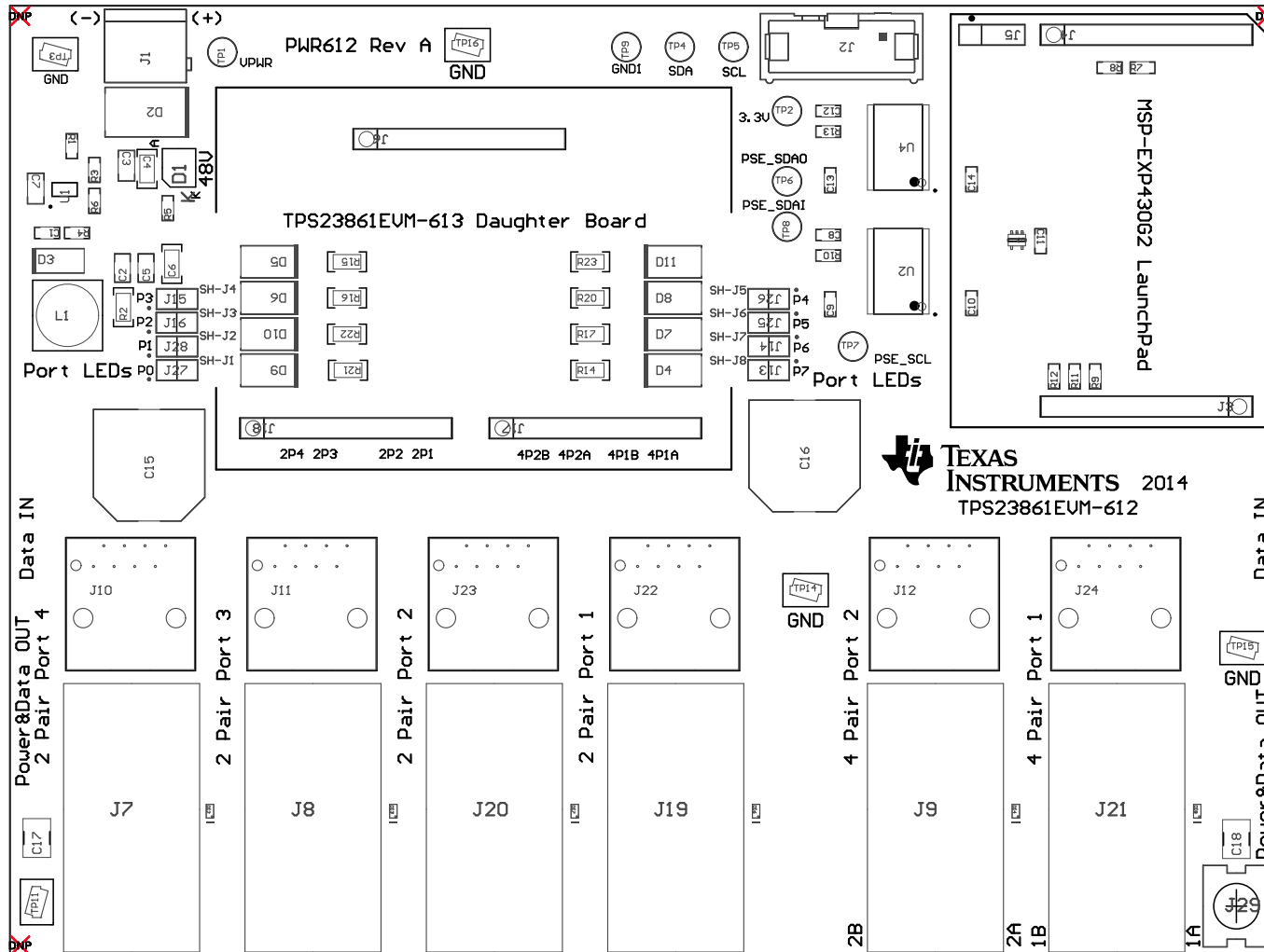


Z21 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.

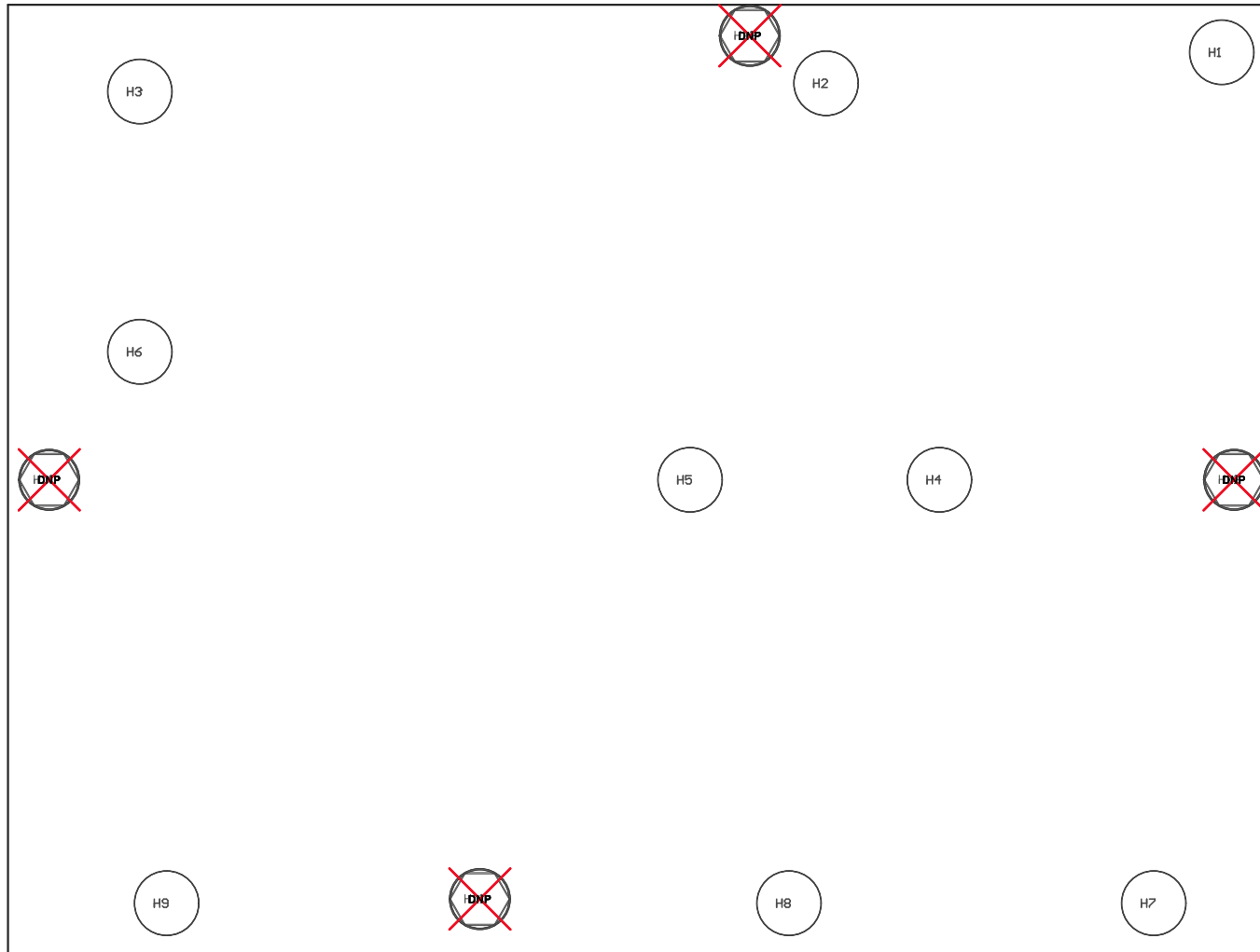
Z22 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Z23 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PWR612	REV: A	SUN REV: Not In VersionControl
IGNORE -> Top Overlay			
PLOT NAME = Top Assembly Drawing	GENERATED : 2/7/2014	2:19:18 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PWR612	REV: A	SUN REV: Not In VersionControl
	IGNORE -> Bottom Overlaid		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 2/7/2014	2:19:20 PM	TEXAS INSTRUMENTS

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